imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

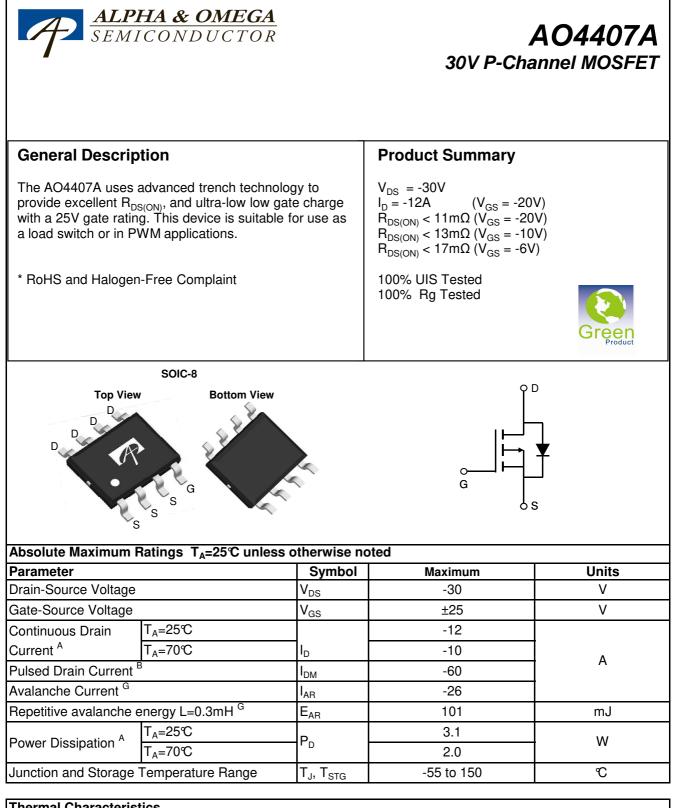
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Thermal Characteristics									
Parameter		Symbol	Тур Мах		Units				
Maximum Junction-to-Ambient ^A	t ≤ 10s	P	32	40	°C/W				
Maximum Junction-to-Ambient ^A	Steady State	R _{θJA}	60	75	°C/W				
Maximum Junction-to-Lead ^C	Steady State	$R_{ ext{ hetaJL}}$	17	24	°C/W				

Electrical Characteristics (T _J =25°C unless o	therwise noted)
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Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_{D} = -250 \mu A, V_{GS} = 0 V$	-30			V
I _{DSS} Zero Gate Voltage Drair	Zara Cata Valtaga Drain Current	$V_{DS} = -30V, V_{GS} = 0V$			-1	
		$T_{\rm J} = 55^{\circ}C$			-5	μA
I _{GSS}	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 25V$			±100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = -250 \mu A$	-1.7	-2.3	-3	V
I _{D(ON)}	On state drain current	$V_{GS} = -10V, V_{DS} = -5V$	-60			Α
R _{DS(ON)} Static Drain-Source		$V_{GS} = -20V, I_D = -12A$		8.5	11	
	Statia Drain Sauras On Desistance	T_=125℃		11.5	15	
	Static Drain-Source On-Resistance	$V_{GS} = -10V, I_D = -12A$		10	13	mΩ
		$V_{GS} = -6V, I_D = -10A$		12.7	17	
g _{FS}	Forward Transconductance	$V_{DS} = -5V, I_{D} = -10A$		21		S
V _{SD}	Diode Forward Voltage	$I_{S} = -1A, V_{GS} = 0V$		-0.7	-1	V
I _S	Maximum Body-Diode Continuous Current				-3	А
DYNAMIC	C PARAMETERS					
C _{iss}	Input Capacitance			2060	2600	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		370		pF
C _{rss}	Reverse Transfer Capacitance]		295		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		2.4	3.6	Ω
SWITCHI	NG PARAMETERS					
Q _g	Total Gate Charge			30	39	nC
Q _{gs}	Gate Source Charge	V_{GS} =-10V, V_{DS} =-15V, I_{D} =-12A		4.6		nC
Q _{gd}	Gate Drain Charge]		10		nC
t _{D(on)}	Turn-On DelayTime			11		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_{L} =1.25 Ω ,		9.4		ns
t _{D(off)}	Turn-Off DelayTime	R _{GEN} =3Ω		24		ns
t _f	Turn-Off Fall Time] [12		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-12A, dl/dt=100A/μs		30	40	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-12A, dI/dt=100A/μs		22		nC

A: The value of R_{eJA} is measured with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}$ C. The value in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

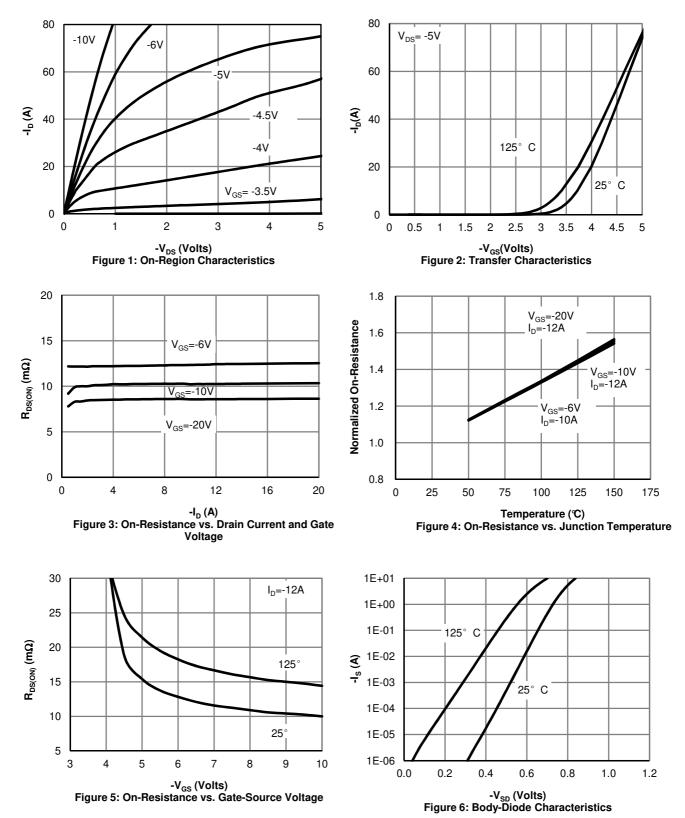
D. The static characteristics in Figures 1 to 6 are obtained using < 300µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The SOA curve provides a single pulse rating.

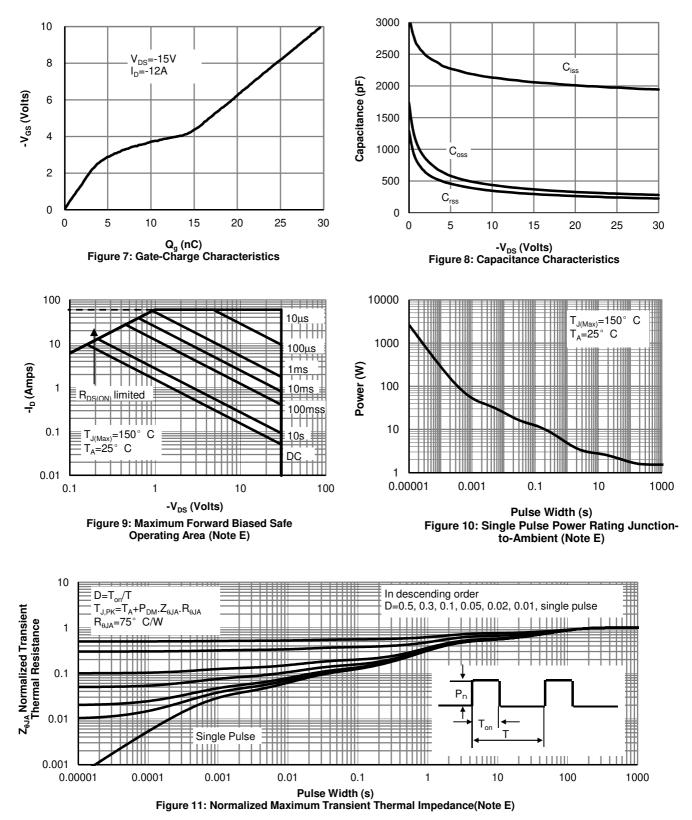
F. The current rating is based on the t \leq 10s thermal resistance rating.

G. E_{AR} and I_{AR} ratings are based on low frequency and duty cycles to keep $T_i=25C$.

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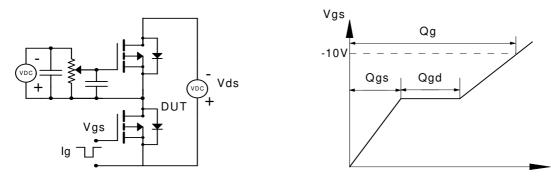
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



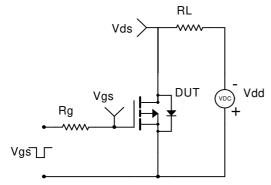
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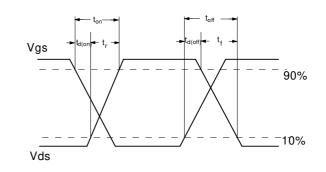
Rev.11.0 June 2013

Gate Charge Test Circuit & Waveform

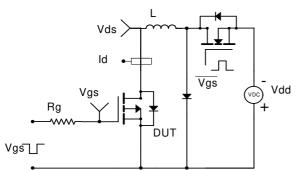


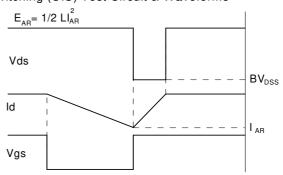
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

